DSC2311KM2-R0067



Crystal-lessTM Configurable Clock Generator

General Description

DSC2311KM2-R0067 is a crystal-less clock generator that is factory configurable to simultaneously output two separate frequencies from 2.3 to 170MHz. The generator uses proven silicon technology to provide low jitter and high frequency stability across a wide range of supply voltages and temperatures. By eliminating the external quartz crystal, crystal-less clock generators significantly enhance reliability and accelerate product development, while meeting stringent clock performance criteria for a variety of consumer electronics, communications, and storage applications.

DSC2311KM2-R0067 has an output enable/disable feature allowing it to disable the outputs when OE is low. The device is available in a space-saving 6-pin 2.5mm x 2.0mm TDFN package that needs only a single external bypass capacitor. This requires a PCB footprint equivalent to that of a 1.0mm x 1.0mm crystal-based clock generator.

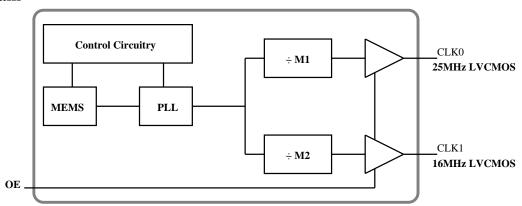
Applications

- Consumer Electronics
- Camera and Imaging Modules
- Home Automation
- Industrial and Power Conversion
- Mobile Communications, Internet, and Sensor Devices
- · Solid State, Hard Drive, and Flash Drive Storage
- Automotive

Features

- Two simultaneous LVCMOS outputs:
- 25MHz
- 16MHz
- Low RMS phase jitter: <1ps (typical)
- ±25ppm frequency stability
- -55°C to +125°C automotive temperature range
- High supply noise rejection: -50dBc
- High shock & vibration immunity
 - Qualified to MIL-STD-883
- High reliability
- 20x higher MTBF than crystal-based clock generator designs
- Programmable output strength for EMI reduction and signal integrity optimization
- Supply range of 2.25 to 3.6V
- 6-pin 2.5mm x 2.0mm TDFN package

Block Diagram



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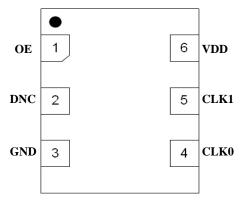
http://www.microchip.com

Ordering Information

| Ordering Part Number | Industrial Temperature Range | Shipping | Package |
|----------------------|------------------------------|---------------|--------------------------|
| DSC2311KM2-R0067 | -55°C to +125°C | Tube | 6-pin 2.5mm x 2.0mm TDFN |
| DSC2311KM2-R0067T | -55°C to +125°C | Tape and Reel | 6-pin 2.5mm x 2.0mm TDFN |

Devices are Green and RoHS compliant. Sample material may have only a partial top mark.

Pin Configuration



6-pin 2.5mm x 2.0mm TDFN

Pin Description

| Pin Number | Pin Name | Pin Type | Pin Level | Pin Function |
|------------|----------|----------|-----------|---|
| 1 | OE | I | | Active high output enable for CLK0 and CLK1 |
| 2 | DNC | | | Leave unconnected or connect to the ground |
| 3 | GND | PWR | | Power supply ground |
| 4 | CLK0 | О | LVCMOS | CLK0 output frequency = 25MHz |
| 5 | CLK1 | О | LVCMOS | CLK1 output frequency = 16MHz |
| 6 | VDD | PWR | | Power supply |

Specifications (Unless specified otherwise: $T = 25^{\circ}C$, VDD = 3.3V)

| Parameter | Symbol | Condition | Min. | Тур. | Max. | Units |
|---|------------|---|----------------|--------------------|----------------|-------|
| Supply Voltage ¹ | VDD | | 2.25 | | 3.6 | V |
| Supply Current ² | IDD | OE pin low - outputs are disabled | | 21 | 23 | mA |
| Frequency Stability ⁶ | ΔF | Includes frequency variation due to initial tolerance, temp. and power supply voltage | | ±25 | | ppm |
| Aging | ΔF | First year (@ 25°C) | | | ±5 | ppm |
| Startup Time ³ | tSU | T = 25°C | | | 5 | ms |
| Input Logic High Input Logic Low | VIH VIL | | 0.75 x VDD | | 0.25 x VDD | V |
| Output Disable Time ⁴ | tDA | | | | 5 | ns |
| Output Enable Time ⁴ | tEN | | | | 20 | ns |
| Pull-Up Resistor ² | | Pull-up exists on pin 1 | | 40 | | kOhms |
| Output Logic High Output Logic Low | VOH VOL | $I = \pm 6mA$ | 0.9 x VDD - | | - 0.1 x VDD | V |
| Output Transition Time ⁴ Rise Time Fall Time | tR tF | 20% to 80% CL = 15pF | | 1.1 1.43 | 2 2 | ns |
| Frequency | F0 F1 | CLK0 CLK1 | | 25 16 | | MHz |
| Output Duty Cycle | SYM | | 45 | | 55 | % |
| Period Jitter ⁵ | JPER | CLK0 = CLK1 = 25MHz | | 3 | | psRMS |
| Integrated Phase Noise | JCC | 200kHz to 20MHz @ 25MHz 100kHz to 20MHz @ 25MHz 12kHz to 20MHz @ 25MHz | | 0.3 0.38 1.7 | 2 | psRMS |

Notes:

- 1. Pin 4 VDD should be filtered with 0.1uF capacitor.
- 2. Output is enabled if OE pad is high or not connected. Supply current = Disabled Current + Δ IDD from CLK0 + Δ IDD from CLK1. See Current Consumption graph on next page.
- 3. tSU is time to stable output frequency after VDD is applied and outputs are enabled.
- 4. See Figure 3 for detail (all based on maximum drive settings).
- 5. Period Jitter includes crosstalk from adjacent output.
- $6.\ For\ other\ ppm\ stabilities,\ contact\ the\ factory\ at\ MEMS_Support@microchip.com.$

Absolute Maximum Ratings

| Item | Min. | Max. | Units | Condition |
|----------------|------|---------------------|-------|------------|
| Supply Voltage | -0.3 | +4.0 | V | |
| Input Voltage | -0.3 | VDD + 0.3 | V | |
| Junction Temp | - | +150 | °C | |
| Storage Temp | -55 | +150 | °C | |
| Soldering Temp | - | +260 | °C | 40sec max. |
| ESD HBM MM CDM | - | 4000 400 1500 | V | |

Current Consumption

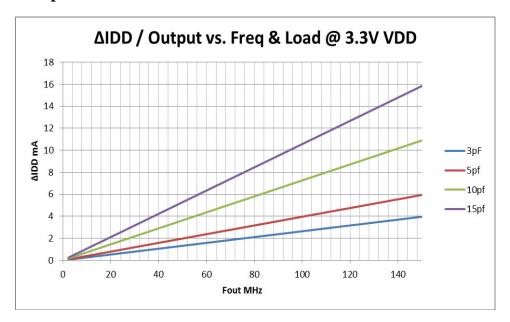


Figure 1. Total Current = Disabled Current + \triangle IDD Fout1 + \triangle IDD Fout2

Solder Reflow Profile

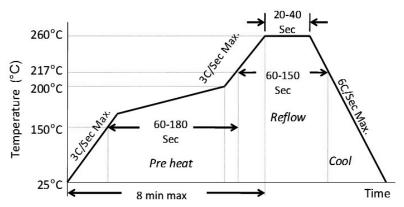


Figure 2. Solder Reflow Profile

| 6 QFN MSL 1 @ 260°C refer to JSTD-020C | | | |
|--|--------------|--|--|
| Ramp-Up Rate (200°C to Peak Temp) | 3°C/sec Max. | | |
| Preheat Time 150°C to 200°C | 60 - 180 sec | | |
| Time maintained above 217°C | 60 - 150 sec | | |
| Peak Temperature | 255 - 260°C | | |
| Time within 5°C of actual Peak | 20 - 40 sec | | |
| Ramp-Down Rate | 6°C/sec Max. | | |
| Time 25°C to Peak Temperature | 8 min Max. | | |

OE Function and Output Waveform

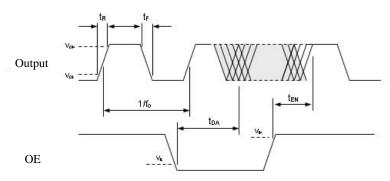
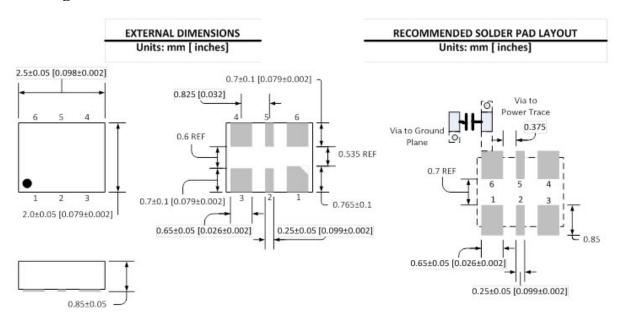


Figure 3. OE Function and Output Waveform

Package Information⁷



6-pin TDFN (2.5mm x 2.0mm)

Note:

7. Package information is correct as of the publication date. For updates and most current information, go to www.microchip.com.

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